Extending IMU Degrees of Freedom for Pose Estimation Using AI on Chip

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Introduction

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Who Are We?

Chirag Rastogi

- o Computer Engineer
- Created software to run the algorithms and designed the Neural Network

Lukas Zscherpel

- o Computer Engineer
- o Designed and Programmed PCB







Objective

The Problem

What is an IMU?

Inertial Measurement Units identify position in space using 3 sensors:

Accelerometer

- Measures linear acceleration in three 0 dimensions
- Used to estimate velocity and Ο position over time

Gyroscope

- Measures angular acceleration in three dimensions \cap
- Used to estimate orientation over Ο time

Magnetometer

- Measures the direction of the Earth's 0 magnetic field Used to estimate orientation with
- 0 respect to Earth's magnetic field

Issues With Current IMU's

Accuracy Ο

- To estimate position in space, you Ο differentiate sensor outputs
- Differentiating the data causes Ο small errors to explode
- Most affordable IMU's have low 0 levels of accuracy and high error

Price Ο

- There are many IMU's with high Ο accuracy available
- High accuracy IMU's typically run 0 for hundreds of dollars



The Solution

Using Traditional Filters

- Kalman Ο
- Madgwick Ο
- Mahony Ο

An AI on chip solution may have the potential to reduce the cost of 9DOF IMU sensors by enabling the integration of multiple sensors and processing functions onto a single chip, which can simplify the design, reduce the bill of materials, and lower the manufacturing costs.



RNN 0

LSTM 0

Bidirectional LSTM 0





High Level Overview

Ι

High Level Overview

Project Components:

o IMU Dev Board

- Provides sensor data from IMU to external device through USB
- Allows for IMU to be easily swapped
- Provides UI for IMU calibration

o Data Processing and Display

- Processes data on GPU or CPU
- Improves accuracy of the data using filtering or AI
- Displays the data through a 3D visual of device orientation





Enhanced Inertial Measurement Unit



1/0 Connector **MPU 6050** 6 DOF Includes accelerometer and gyroscope ~\$3 **MPU 9250**

9 DOF 0

0

0

Ο

0

Ο

- Includes accelerometer, gyroscope 0 and magnetometer
- Offers improved sensor accuracy Ο over MPU 6050
- ~\$6 0

Subsystem 1: Inertial Measurement Unit

Standard IMU's



SIX DEGREES OF FREEDOM



Subsystem 2: Control Unit

Components

• ESP32-WROOM-32 microcontroller

- Reads data from IMU through I2C protocol
- Standard microcontroller
- Affordable ~ \$5
- Low power consumption

o USB to UART IC - CP2102N

- Interface between microcontroller and USB connection
- Compatible with standard serial IO protocols and libraries

o 128x64 OLED display

- Helps interface with user for calibration
- o Displays data collected in real time





Subsystem 3: Position Estimation using AI on Chip

The data we used for this project is collected from 2 IMUs as shown below. The IMUs used are MPU-6050.

We investigated to what extent the limitations of standard algorithms can be overcome by means of neural networks

Model: "sequential_2"		
Layer (type)	Output Shape	Param #
lstm_2 (LSTM)	(None, 64)	18176
dense_1 (Dense)	(None, 1)	65
Total params: 18,241 Trainable params: 18,241 Non-trainable params: 0		







Subsystem 4: Power Supply

Components

- Power is supplied from Micro-USB adapter at 5V
- o Voltage Regulator reduces 5V to 3.3V
- 3.3V is supplied to other parts through copper lines on PCB







Short Pin Roll Mouth



Results

PCB Dev Board

Development

o **Design**

- Uses surface mount parts for compact design
- Uses 2 transistor method to automatically enable boot mode
- 3D printed legs allow for more stable calibration
- Plug and Play IMU connection

o Soldering

- Failed when trying to hand solder each part
- Successfully soldered using solder paste and oven

o Programming

- Programmed using the Arduino IDE
- Uses standard Arduino libraries





Programming and Calibration

Data Transmission State

- Sends data at 250 Hz through serial port
- o Data includes:
 - Microcontroller State
 - o Accelerometer x, y, and z
 - Gyroscope x, y, and z
 - Magnetometer x, y, and z
 - Timestamp
- Receiving computer displays attitude estimation

Calibration State

o Accelerometer

- Expect sensors to read zero when device is stationary
- Calibration is done on each axis (X, Y, Z)

o **Gyroscope**

- Ferraris calibration method
- Involves rotating IMU in 360°

o Magnetometer

- Hard Iron Offset
- Rotate the IMU in a sphere to get magnetometer readings in each orientation



+z-dir



Calibration Test Results



18



Standard Algorithms

Filtering and AI

Extended Kalman Filter 40Hz, Madgwick Filter 125Hz, Mahony Filter 160Hz 9250 at 400HZ (I2C at 400kHz or SPI at 1MHz)

Plot of IMU pose estimate (Yaw) values and encode Plot of IMU pose estimate (Yaw) values and encoder value 3.0 2.5 2.0 n 1.5 10 0.5

Sample time (s/100)

2



LSTM





Got an RMSE of < 0.1 degrees over 20 mins

Demo





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Successes and Challenges

Successes

We were able to meet all our high-level Requirements

- For the Neural Network, the IMU interfacing system was able to accurately measure and monitor the orientation and movement of a device to within a maximum error of 3 degrees and 0.5 cm/s
- The system was able to perform calibration on the data outputted by the IMU to within a maximum error of 0.5 degrees and 0.2 cm/s.
- Due to the performance of the standard algorithms, we chose to stick with the Neural Network as the primary algorithm





Challenges



NVidia Jetson Implementation

- o **Booting Issues**
 - We had issues getting started with the Jetson Board

Assembling the PCB

o Delays

- Shipping delays made parts come in last minute
- Unable to iterate PCB design due to delays
- Limited time for testing algorithms on data coming from PCB

• Soldering

- Surface mounted IC's are HARD to solder
- Took multiple attempts to get working

• Programming

- Had issues programming using micropython in Thonny IDE
- Had to redesign program from initial IMU testing breadboard

Failed Requirements



• We could not get any standard algorithm to give us a MSE of <5% over 20 minutes, therefore we could not perform selection

Error in Radians





Conclusions

What We Learned



Soft Skills

- Scope, schedule, and resources are all important when designing a project
- Good communication between team members is vital to succeed
- Starting early helps to prepare better for the unexpected
- Most important: things never go as planned

Hard Skills

- How to solder surface mount IC's
- How do design a PCB from scratch
- Learned how the three main algorithms worked and their applications
- Learned how to communicate between computer and pcb dev board

What We Would Change





Moving Forward



Thank You

Questions?